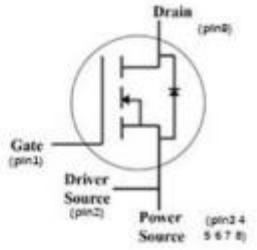
Silicon Carbide Power MOSFET （N-Channel Enhancement）

V_{DS}	750V
$I_{D\ (25°C)}$	61A
$R_{DS(on)}$	40mΩ







Features

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free, RoHS compliant

Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

Mechanical Data

- **Package**: TOLL
- **Terminals**: Tin plated leads
- **Polarity**: As marked

■Maximum Ratings (T_C=25℃ Unless otherwise specified）

PARAMETER	SYMBOL	UNIT	VALUE	TEST CONDITIONS	NOTE
Device marking code			D207550TLYG3		
Drain source voltage @ T_j=25°C	$V_{DS,max}$	V	750	V_{GS}=0V, I_D=100uA	
Gate source voltage @ T_j=25°C	$V_{GS,max}$	V	-8/+22	Absolute maximum values (AC f >1Hz, duty cycle < 1%)	
Gate source voltage @ T_j=25°C	$V_{GS,op}$	V	-5/+18	Recommended operational values	
Continuous drain current @ T_c=25°C	I_D	A	61	V_{GS}=18V, Tc=25℃	Fig.17
Continuous drain current @ T_c=100°C			41	V_{GS}=18V, Tc=100℃	
Pulsed drain current	$I_{D(pulsed)}$	A	145	Pulse width t_p limited by $T_{j,max}$	Fig.22
Avalanche energy,Single Pulse	E_{AS}	mJ	627	V_{DD}=75V,L=10mH	
Power Dissipation	P_{TOT}	W	194.8	T_c=25°C , Tj = 175℃	Fig.16
Power Dissipation			97	T_c=100°C, Tj = 175℃	
Operating junction and Storage temperature range	Tj ,Tstg	°C	-55 to +175		
Soldering temperature	T_L	°C	260	1.6mm (0.063'') from case for 10s	
Mounting torque	T_M	Nm	0.6	M3 screw Maximum of mounting process: 3	

■Static Electrical Characteristics（Tc=25℃ unless otherwise specified ）

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Gate threshold voltage	$V_{GS(th)}$	V	2.0	3.0	4.0	V_{DS}=V_{GS}, I_D= 8mA	Fig.4, 11
				2.2		V_{DS}=V_{GS}, I_D= 8mA, Tj=175℃	
Drain source breakdown voltage	$V_{(BR)DSS}$	V	750			V_{GS}=0V, I_D=100uA	
Drain source leakage current	I_{DSS}	uA		10	100	V_{DS}=750V, V_{GS}=0V	
Gate source leakage current	I_{GSS}	nA		10	100	V_{GS}= 18V, V_{DS}=0V	
Current drain source on-state resistance	$R_{DS\ ON}$	mΩ		46		V_{GS}=15V, I_D=20A	Fig.5, 6, 7
				40	52	V_{GS}=18V, I_D=20A	
				60		V_{GS}=15V, I_D=20A,Tj=175℃	
				55		V_{GS}=18V, I_D=20A,Tj=175℃	
Transconductance	g_f	S		14.5		V_{DS}=20V,I_D=20A	Fig.4
				14		V_{DS}=20V,I_D=20A,Tj=175℃	

■Dynamic Electrical Characteristics（Tc=25℃ unless otherwise specified ）

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Input capacitance	Ciss	pF		2542		V_{DS}=500V, V_{GS}=0V, Tj=25℃, f=1MHz, V_{AC} = 25mV	Fig.13, 14
Output capacitance	Coss			132			
Reverse capacitance	Crss			5			
Coss stored energy	Eoss	uJ		31			Fig.15
Gate source charge	Qgs	nC		22		V_{DS}=500V, V_{GS}=-5/+18V, I_D=20A	Fig.12
Gate drain charge	Qgd			38			
Gate charge	Qg			82			
Internal gate resistance	Rg	Ω		1.5		f=1MHz	

■Switching Characteristics（Tc=25℃ unless otherwise specified ）

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Turn on delay time	$t_{d(on)}$	ns		12.8		V_{DD}=500V, V_{GS}=-5/+18V, I_D=20A, Rg=2.4Ω, L=100uH	Fig.21
Rise time	t_r			19			
Turn off delay time	$t_{d(off)}$	ns		23.2			
Fall time	t_f			8.3			

Turn on switching energy	E_{on}	uJ		145.7		V_{DD}=500V, V_{GS}=-5/+18V, I_D=20A, Rg=2.4Ω, L=100uH	Fig.19, 20
Turn off switching energy	E_{off}			39.6			

■Body diode characteristics（Tc=25℃ unless otherwise specified ）

PARAMETER	SYMBOL	UNIT	Min.	Typ.	Max.	Test Conditions	Note
Diode forward voltage	V_{SD}	V		4.3		V_{GS}=-5V,I_{SD}=10A	Fig.8
				2.6		V_{GS}=0V, I_{SD}=10A, Tj=175℃	Fig.9
Continuous diode forward current	I_S	A		32		V_{GS}=-5V,Tc=25℃	
Reverse recovery time	trr	nS		16		V_R=500V, V_{GS}=-5V, I_D=20A, di/dt=1000A/uS	
Reverse recovery charge	Qrr	nC		149			
Peak reverse recovery current	Irrm	A		7			

■Thermal Characteristics （Ta=25℃ Unless otherwise specified）

PARAMETER	SYMBOL	UNIT	Typ.
Thermal resistance	$R_{\theta J-C}$	°C /W	0.77

■Typical Characteristics

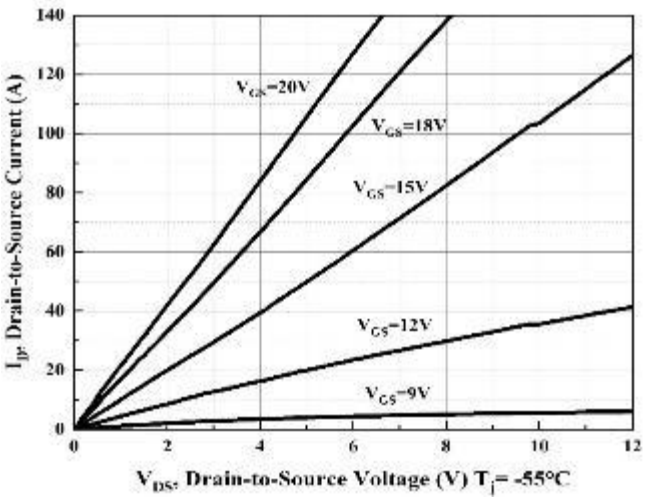


Figure 1. Output Characteristics Tj = -55℃

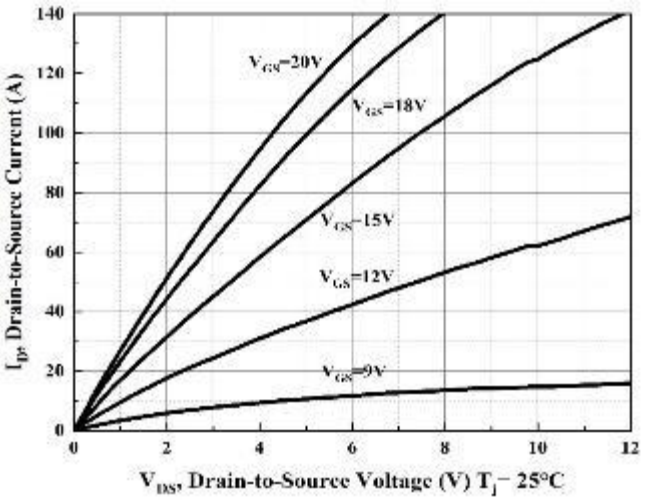


Figure2. Output Characteristics Tj = 25℃

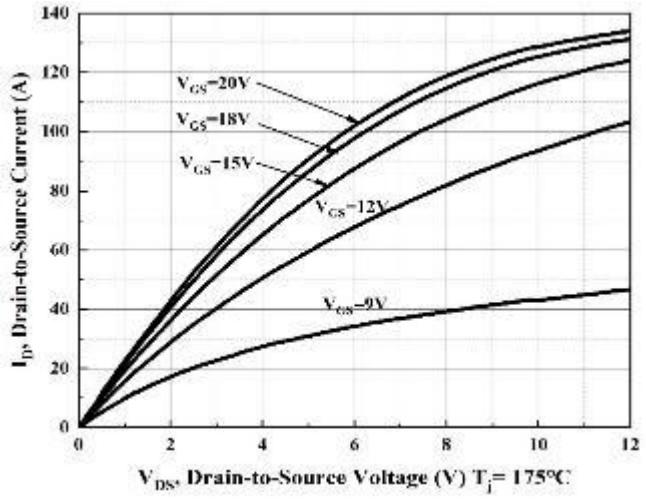


Figure 3. Output Characteristics Tj = 175℃

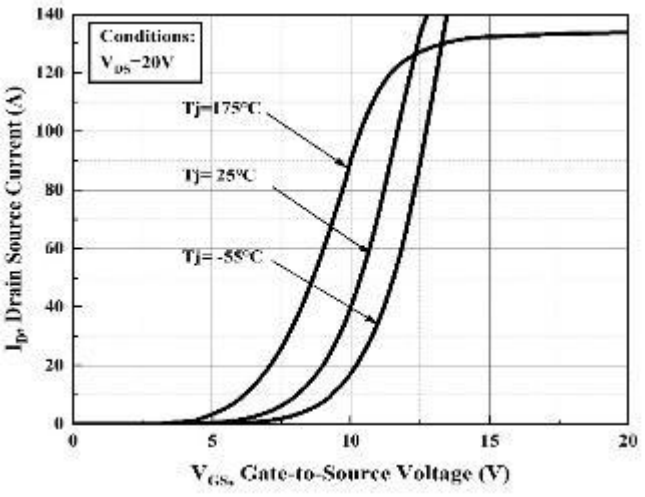


Figure 4. Transfer Characteristics for Various Junction Temperature

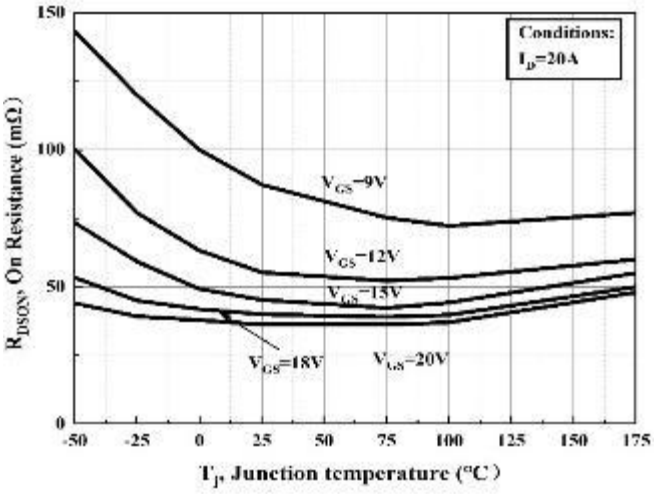


Figure 5. On-resistance vs. Temperature for Various Gate Voltage

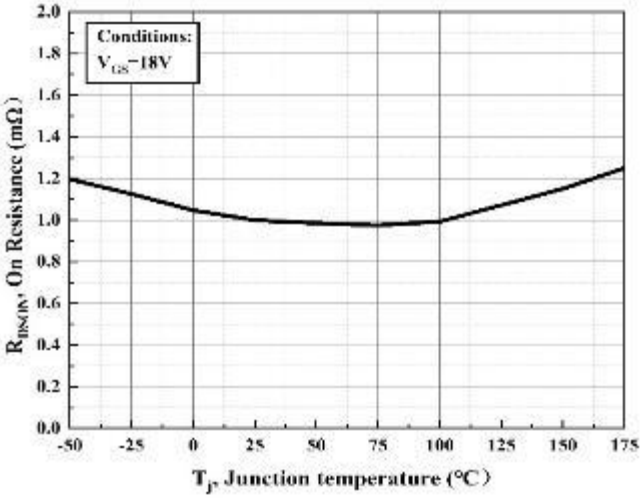


Figure 6. Normalized on-resistance vs. Temperature

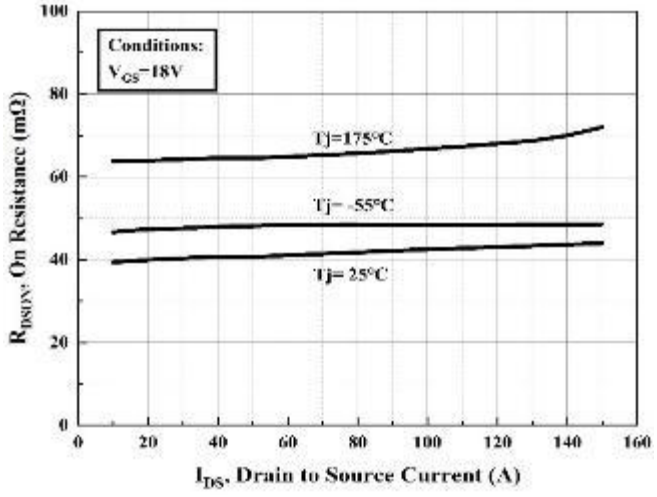


Figure 7. On-resistance vs. Drain Current

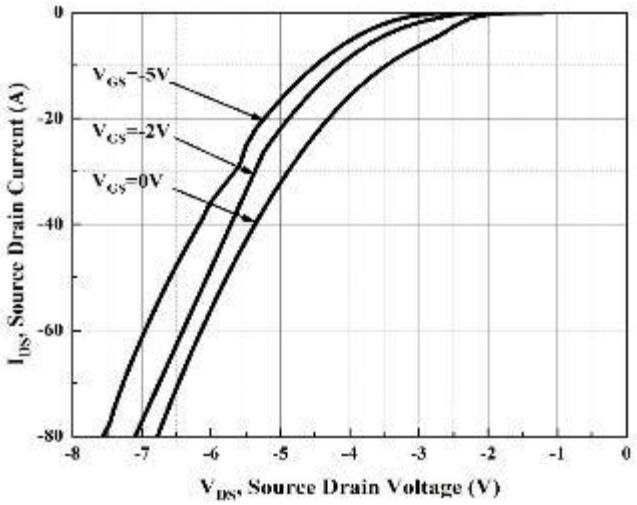


Figure 8. Body Diode Characteristic at Tj= 25 ℃

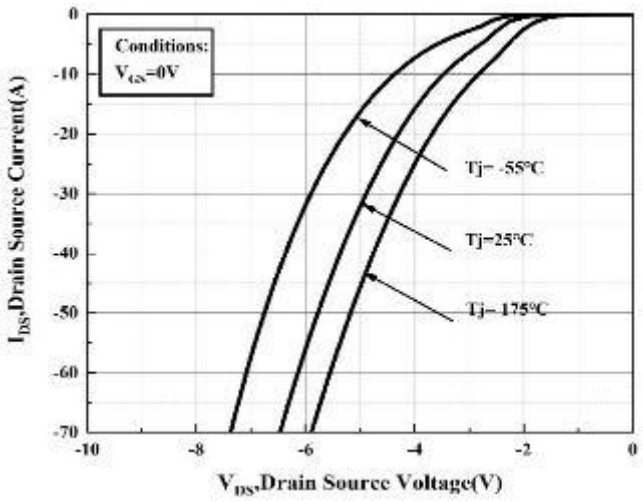


Figure 9. Body Diode Characteristic

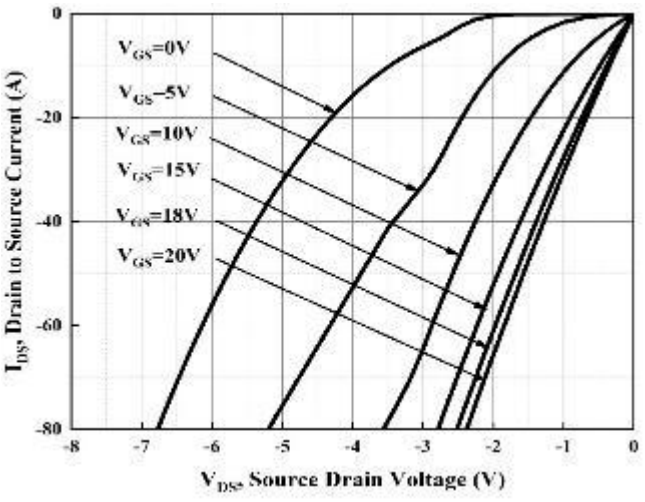


Figure 10. 3rd quadrant Characteristic at Tj= 25 ℃

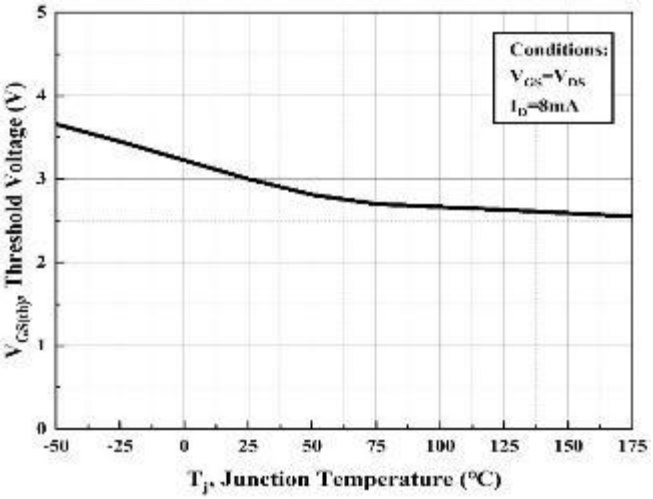


Figure 11. Threshold Voltage vs. Temperature

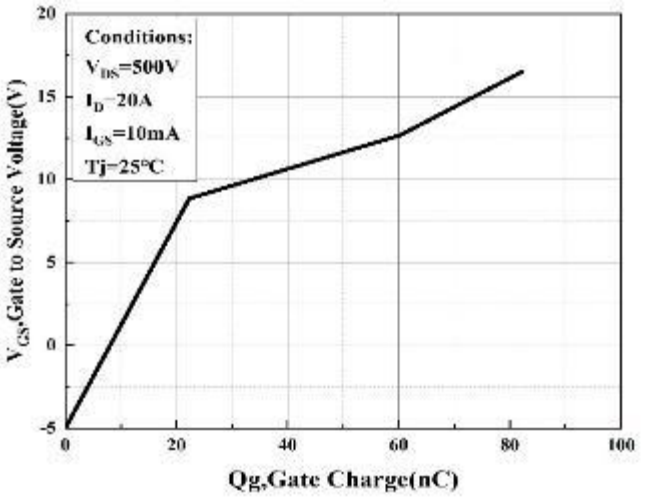


Figure 12. Gate Charge Characteristic

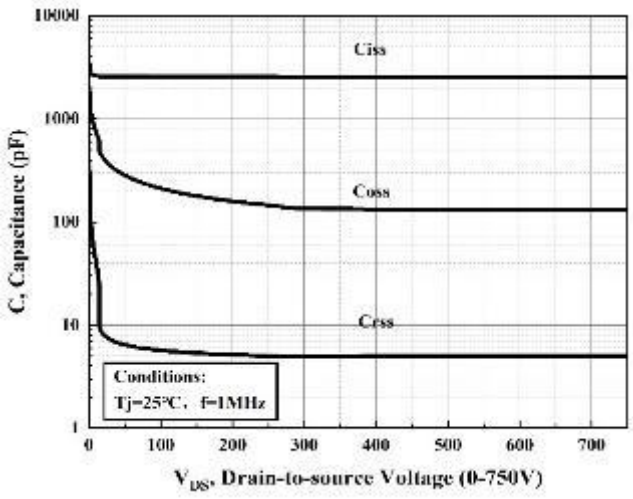


Figure 13. Capacitances vs. Drain Source Voltage (0-750V)

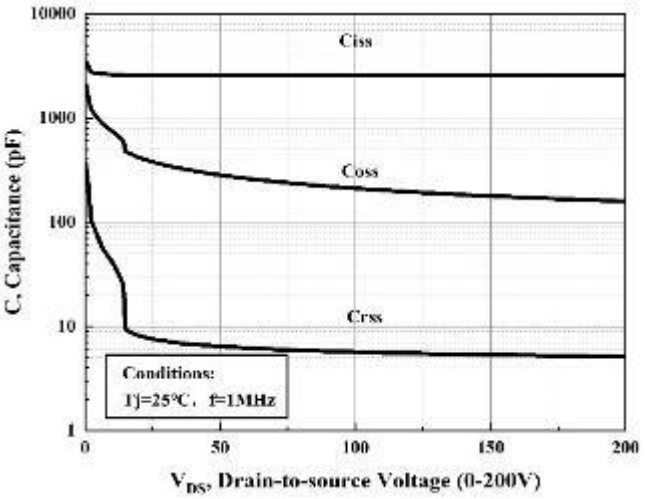


Figure 14. Capacitances vs. Drain Source Voltage (0-200V)

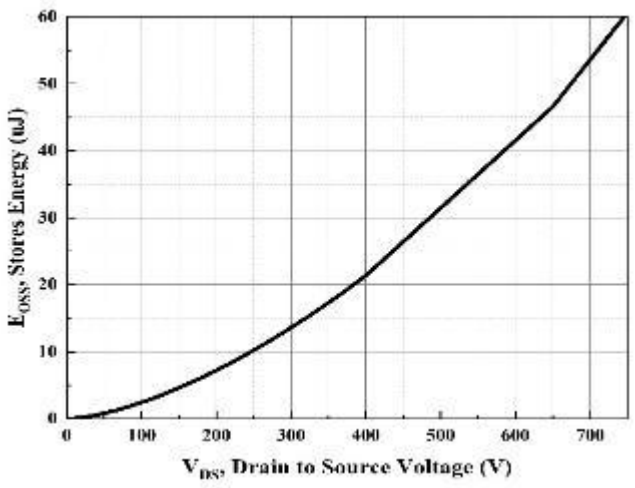


Figure 15. Output Capacitor Stored Energy

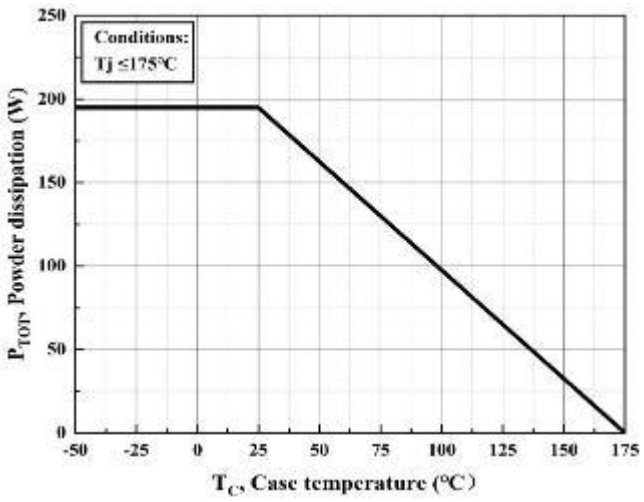


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

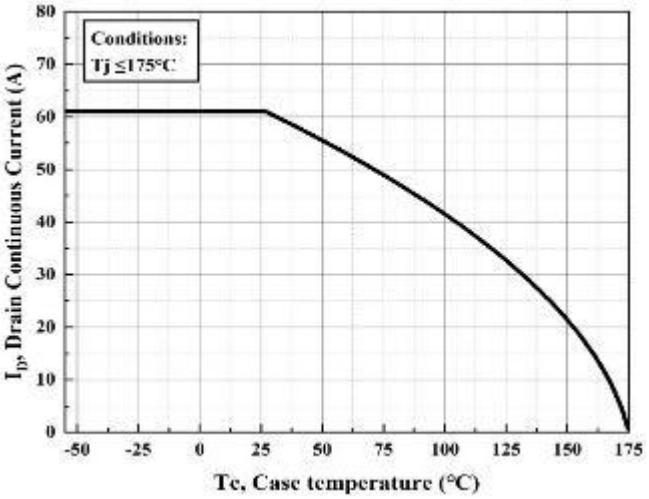


Figure 17. Coutinuous Drain Current Derating vs. Case Temperature

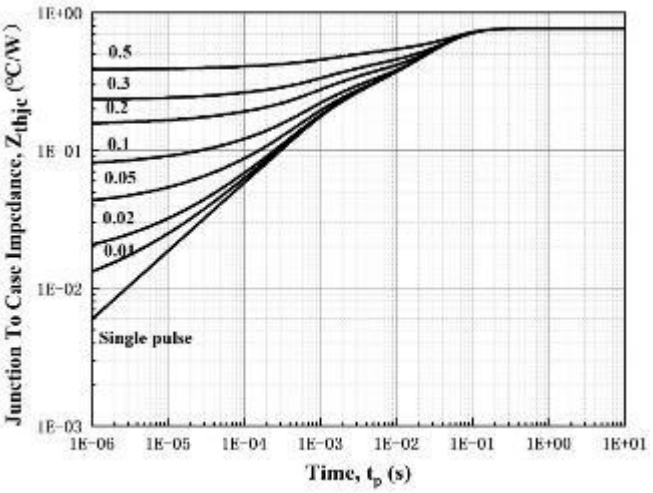


Figure18 Transient Thermal Impedance (Junction - Case)

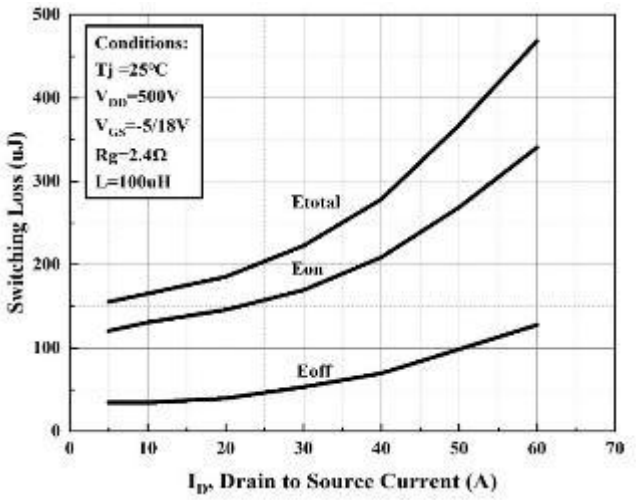


Figure 19. Clamped Inductive Switching Energy vs. Darin Current

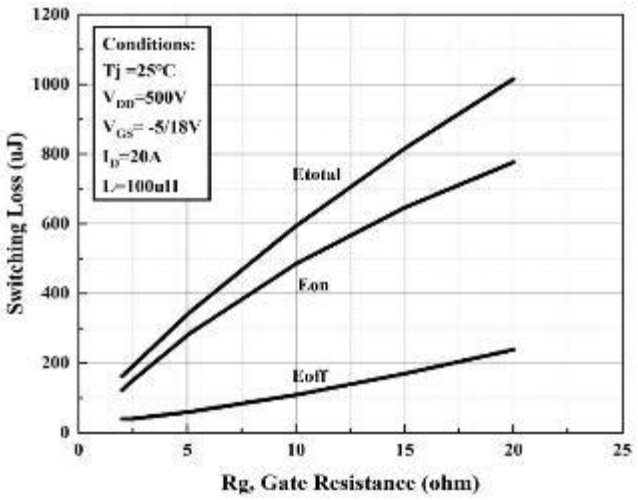


Figure 20. Clamped Inductive Switching Energy vs. Rg

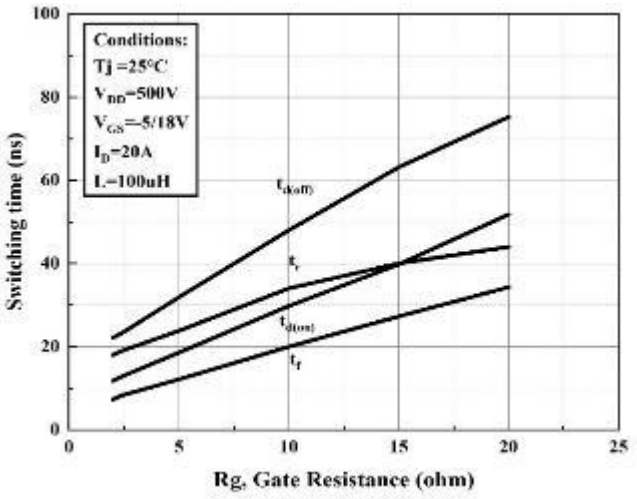


Figure 21. Switching Times vs. Rg

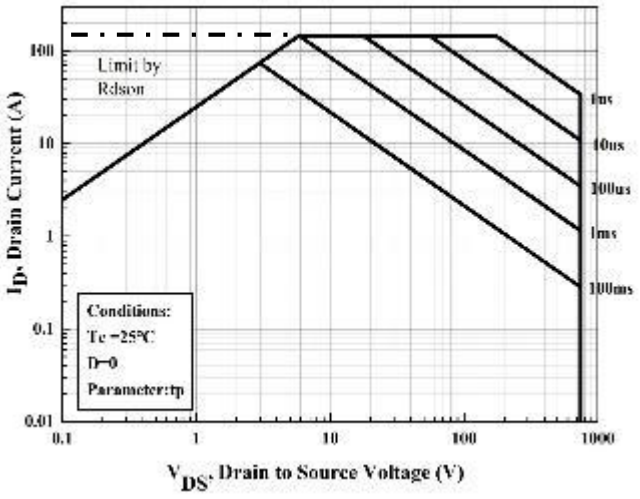


Figure 22. Safe Operating Area

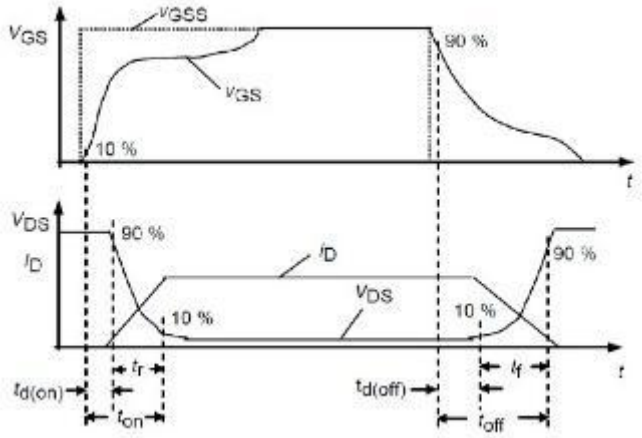


Figure 23. Switching Times Definition

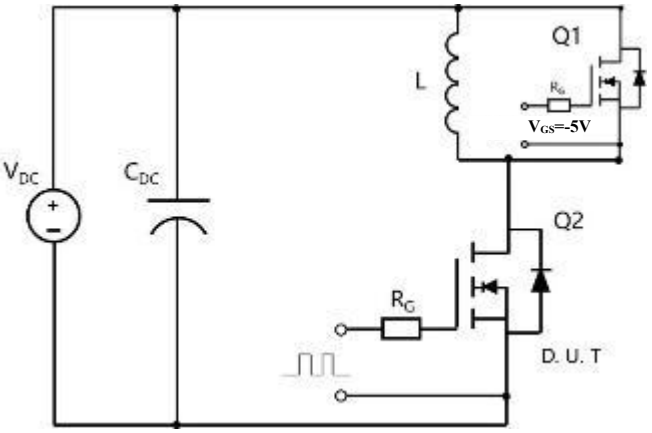
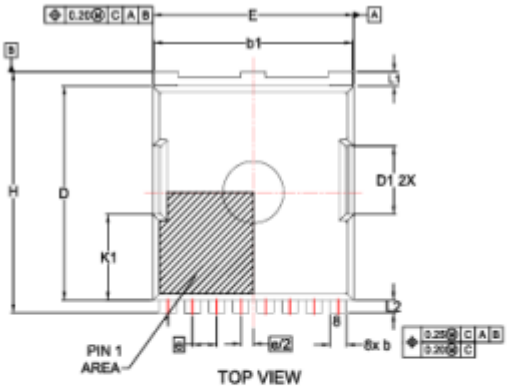


Figure 24. Clamped Inductive Switching Waveform Test Circuit

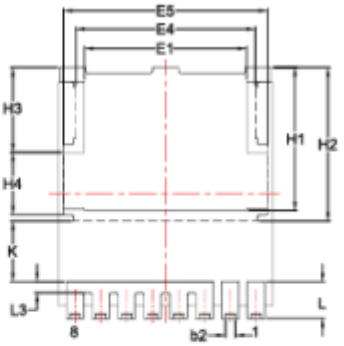
■Outline Dimensions



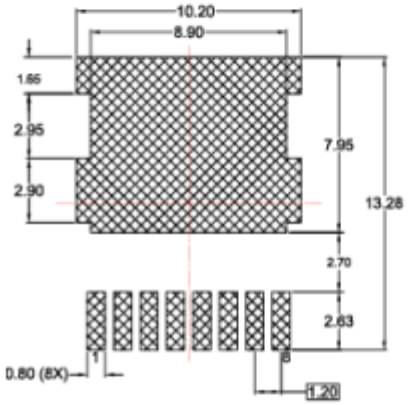
TOP VIEW



SIDE VIEW



BOTTOM VIEW



RECOMMENDED LAND PATTERN

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	2.20	2.3	2.40
A1	1.70	1.80	1.90
b	0.70	0.80	0.90
b1	0.70	0.80	0.90
b2	0.36	0.46	0.56
c	0.40	0.50	0.60
D	10.28	10.38	10.48
D1		3.30	
E	9.80	9.90	10.00
E1	8.0	8.10	8.20
E4		8.40	
E5		9.40	
e		1.20 BSC	
e2		0.60 BSC	
H	11.58	11.68	11.78
H1	6.56	6.66	6.76
H2	7.05	7.15	7.25
H3		3.50	
H4		3.25	
K	2.70	2.80	2.90
K1		4.18	
L	1.63	1.73	1.83
L1	0.60	0.70	0.80
L2	0.50	0.60	0.70
L3	0.30	0.40	0.50
E		8 REF	

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